ALPHA & OMEGA SEMICONDUCTOR

AOT12N65/AOTF12N65/AOTF12N65L/AOB12N65L

650V, 12A N-Channel MOSFET

General Description

The AOT12N65 & AOTF12N65 & AOTF12N65L & AOB12N65L have been fabricated using an advanced high voltage MOSFET process that is designed to deliver high levels of performance and robustness in popular AC-DC applications.
By providing low $R_{DS(on)}$, C_{iss} and C_{rss} along with guaranteed avalanche capability these parts can be adopted quickly into new and existing offline power supply designs.

Product Summary

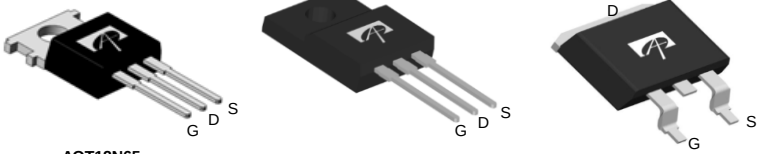
V_{DS}	750V@150℃
I_D (at V_{GS}=10V)	12A
$R_{DS(ON)}$ (at V_{GS}=10V)	< 0.72Ω

100% UIS Tested
100% R_g Tested

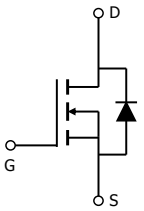
Green Product

Top View

TO-220 / TO-220F / TO-263 D²PAK



AOT12N65 | AOTF12N65(L) | AOB12N65L



Orderable Part Number	Package Type	Form	Minimum Order Quantity
AOT12N65	TO-220 Pb Free	Tube	1000
AOTF12N65	TO-220F Pb Free	Tube	1000
AOTF12N65L	TO-220F Green	Tube	1000
AOB12N65L	TO-263 Green	Tape & Reel	800

Absolute Maximum Ratings T_A=25°C unless otherwise noted

Parameter		Symbol	AOT(B)12N65(L)	AOTF12N65	AOTF12N65L	Units
Drain-Source Voltage		V_{DS}	650			V
Gate-Source Voltage		V_{GS}	±30			V
Continuous Drain Current	T_C=25°C	I_D	12	12*	12*	A
	T_C=100°C		7.7	7.7*	7.7*	
Pulsed Drain Current [C]		I_{DM}	48			
Avalanche Current [C]		I_{AR}	5			A
Repetitive avalanche energy [C]		E_{AR}	375			mJ
Single plused avalanche energy [G]		E_{AS}	750			mJ
MOSFET dv/dt ruggedness		dv/dt	30			V/ns
Peak diode recovery dv/dt			5			
Power Dissipation [B]	T_C=25°C	P_D	278	50	40	W
	Derate above 25°C		2.2	0.4	0.3	W/ °C
Junction and Storage Temperature Range		T_J, T_{STG}	-55 to 150			°C
Maximum lead temperature for soldering purpose, 1/8" from case for 5 seconds		T_L	300			°C

Thermal Characteristics

Parameter	Symbol	AOT(B)12N65(L)	AOTF12N65	AOTF12N65L	Units
Maximum Junction-to-Ambient [A,D]	$R_{\theta JA}$	65	65	65	°C/W
Maximum Case-to-sink [A]	$R_{\theta CS}$	0.5	--	--	°C/W
Maximum Junction-to-Case	$R_{\theta JC}$	0.45	2.5	3.1	°C/W

* Drain current limited by maximum junction temperature.

Electrical Characteristics (T_J=25°C unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
STATIC PARAMETERS						
BV_{DSS}	Drain-Source Breakdown Voltage	I_D=250µA, V_{GS}=0V, T_J=25°C	650			V
		I_D=250µA, V_{GS}=0V, T_J=150°C		750		
BV_{DSS} /ΔTJ	Breakdown Voltage Temperature Coefficient	I_D=250µA, V_{GS}=0V		0.72		V/°C
I_{DSS}	Zero Gate Voltage Drain Current	V_{DS}=650V, V_{GS}=0V			1	µA
		V_{DS}=520V, T_J=125°C			10	
I_{GSS}	Gate-Body leakage current	V_{DS}=0V, V_{GS}=±30V			±100	nA
$V_{GS(th)}$	Gate Threshold Voltage	V_{DS}=5V I_D=250µA	3	3.9	4.5	V
$R_{DS(ON)}$	Static Drain-Source On-Resistance	V_{GS}=10V, I_D=6A		0.57	0.72	Ω
g_{FS}	Forward Transconductance	V_{DS}=40V, I_D=6A		17		S
V_{SD}	Diode Forward Voltage	I_S=1A,V_{GS}=0V		0.71	1	V
I_S	Maximum Body-Diode Continuous Current				12	A
I_{SM}	Maximum Body-Diode Pulsed Current				48	A
DYNAMIC PARAMETERS						
C_{iss}	Input Capacitance	V_{GS}=0V, V_{DS}=25V, f=1MHz	1430	1792	2150	pF
C_{oss}	Output Capacitance		120	152	185	pF
C_{rss}	Reverse Transfer Capacitance		9	11.5	18	pF
R_g	Gate resistance	V_{GS}=0V, V_{DS}=0V, f=1MHz	1.7	3.5	5.3	Ω
SWITCHING PARAMETERS						
Q_g	Total Gate Charge	V_{GS}=10V, V_{DS}=520V, I_D=12A	32	39.8	48	nC
Q_{gs}	Gate Source Charge		7.5	9.2	11	nC
Q_{gd}	Gate Drain Charge		13.5	16.8	20	nC
$t_{D(on)}$	Turn-On DelayTime	V_{GS}=10V, V_{DS}=325V, I_D=12A, R_G=25Ω		36		ns
t_r	Turn-On Rise Time			77		ns
$t_{D(off)}$	Turn-Off DelayTime			120		ns
t_f	Turn-Off Fall Time			63		ns
t_{rr}	Body Diode Reverse Recovery Time	I_F=12A,dI/dt=100A/µs,V_{DS}=100V	300	375	450	ns
Q_{rr}	Body Diode Reverse Recovery Charge	I_F=12A,dI/dt=100A/µs,V_{DS}=100V	6	7.5	9	µC

A. The value of $R_{\theta JA}$ is measured with the device in a still air environment with T_A =25° C.
B. The power dissipation P_D is based on $T_{J(MAX)}$=150° C, using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heatsinking is used.
C. Repetitive rating, pulse width limited by junction temperature $T_{J(MAX)}$=150° C, Ratings are based on low frequency and duty cycles to keep initial T_J =25° C.
D. The $R_{\theta JA}$ is the sum of the thermal impedence from junction to case $R_{\theta JC}$ and case to ambient.
E. The static characteristics in Figures 1 to 6 are obtained using <300 µs pulses, duty cycle 0.5% max.
F. These curves are based on the junction-to-case thermal impedence which is measured with the device mounted to a large heatsink, assuming a maximum junction temperature of $T_{J(MAX)}$=150° C. The SOA curve provides a single pulse rating.
G. L=60mH, I_{AS}=5A, V_{DD}=150V, R_G=25Ω, Starting T_J=25° C

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TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

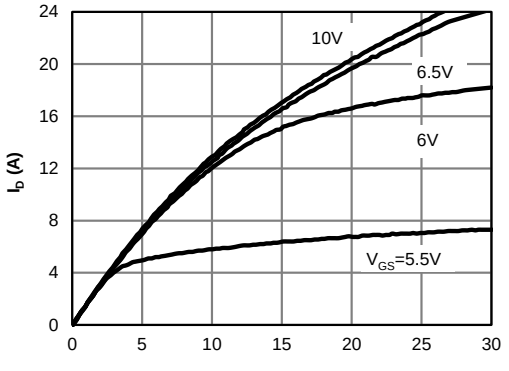


Figure 1: On-Region Characteristics

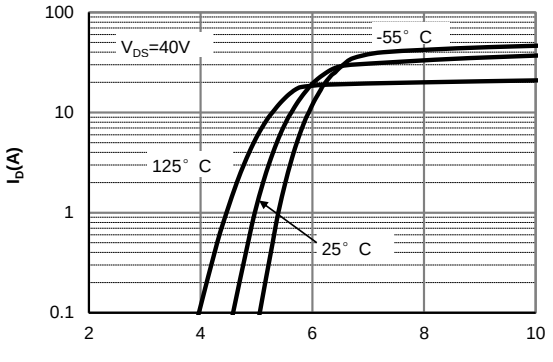


Figure 2: Transfer Characteristics

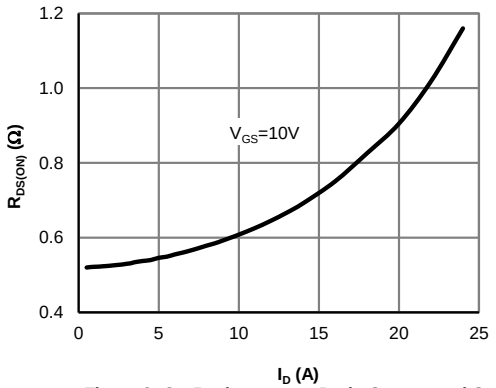


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

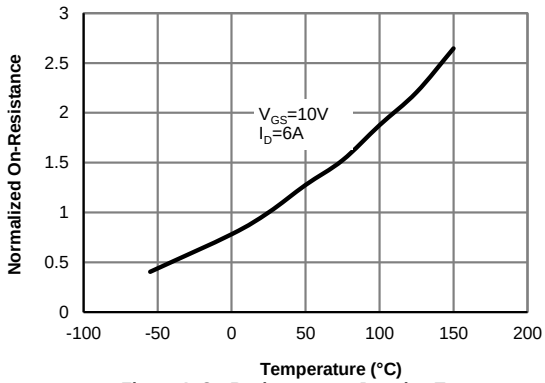


Figure 4: On-Resistance vs. Junction Temperature

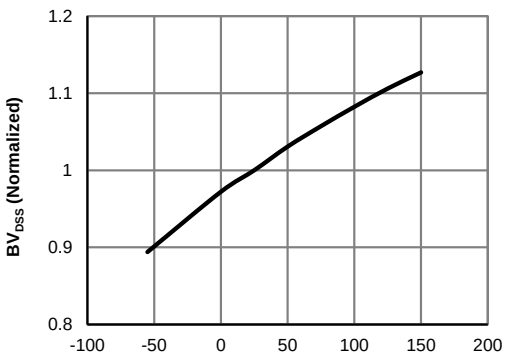


Figure 5: Break Down vs. Junction Temperature

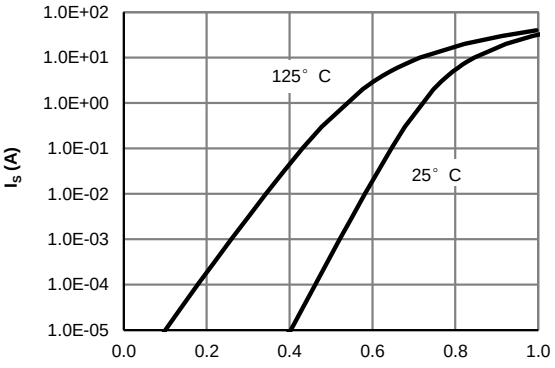


Figure 6: Body-Diode Characteristics (Note E)

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

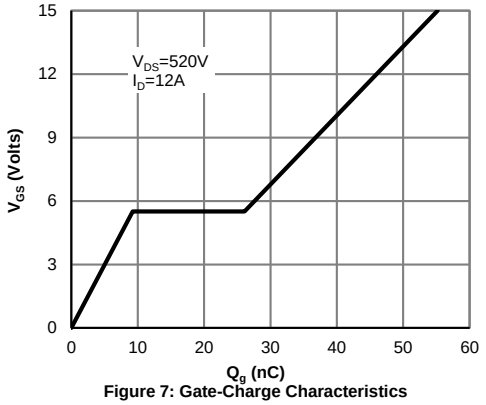


Figure 7: Gate-Charge Characteristics

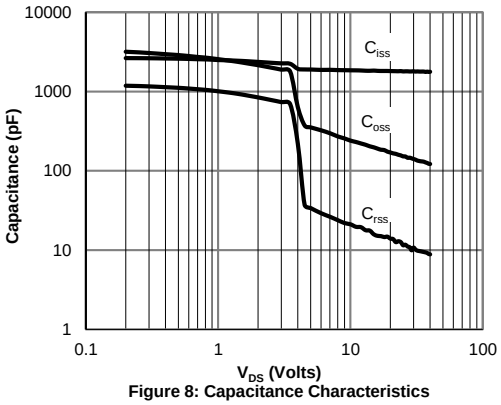


Figure 8: Capacitance Characteristics

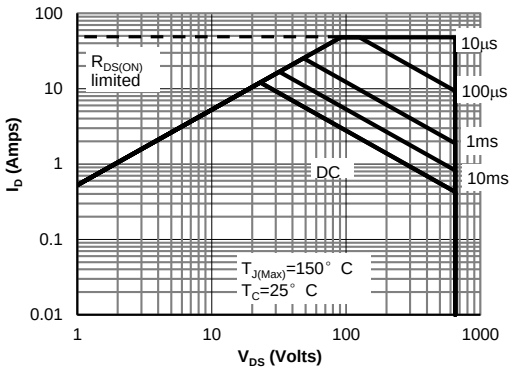


Figure 9: Maximum Forward Biased Safe Operating Area for AOT(B)12N65(L) (Note F)

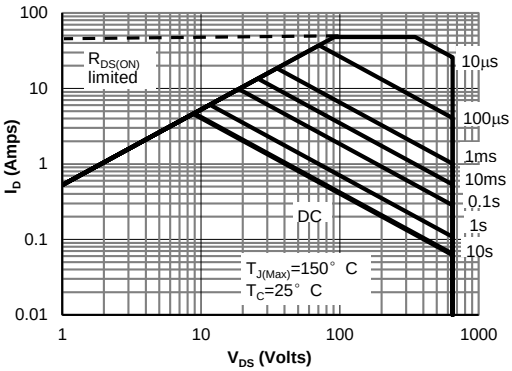


Figure 10: Maximum Forward Biased Safe Operating Area for AOTF12N65 (Note F)

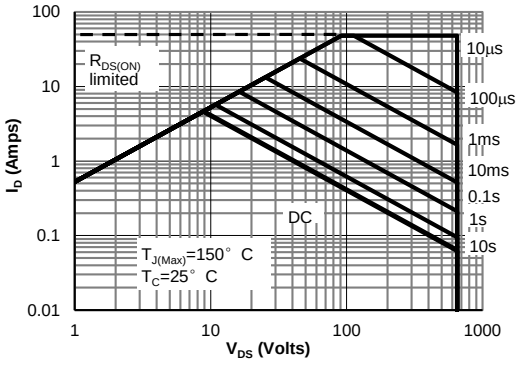


Figure 11: Maximum Forward Biased Safe Operating Area for AOTF12N65L (Note F)

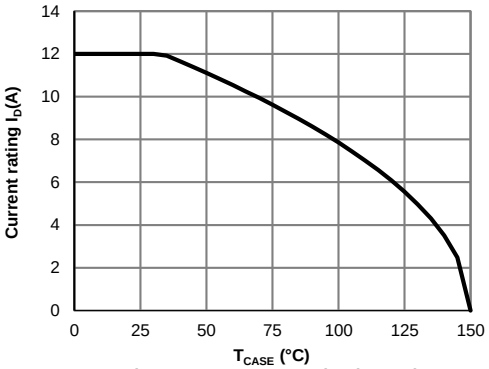


Figure 12: Current De-rating (Note B)

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

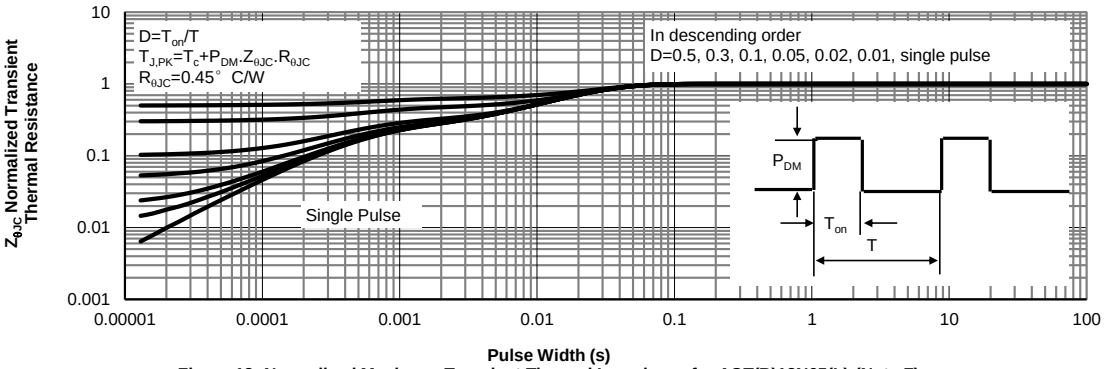


Figure 13: Normalized Maximum Transient Thermal Impedance for AOT(B)12N65(L) (Note F)

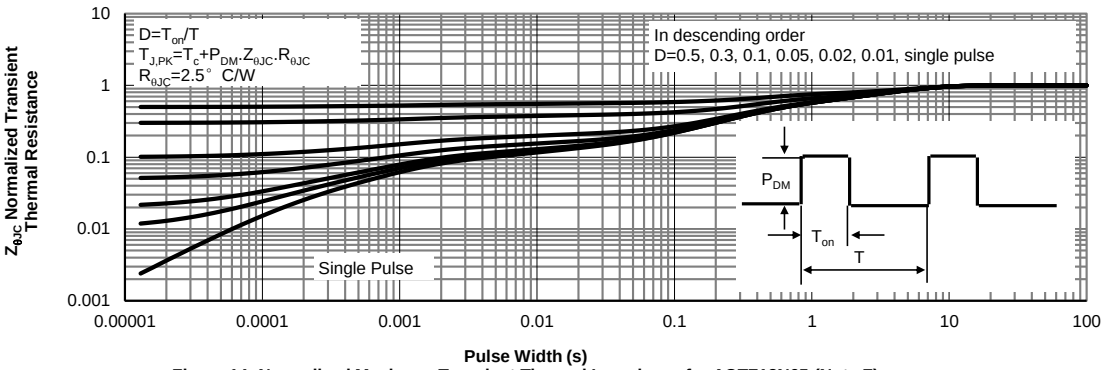


Figure 14: Normalized Maximum Transient Thermal Impedance for AOTF12N65 (Note F)

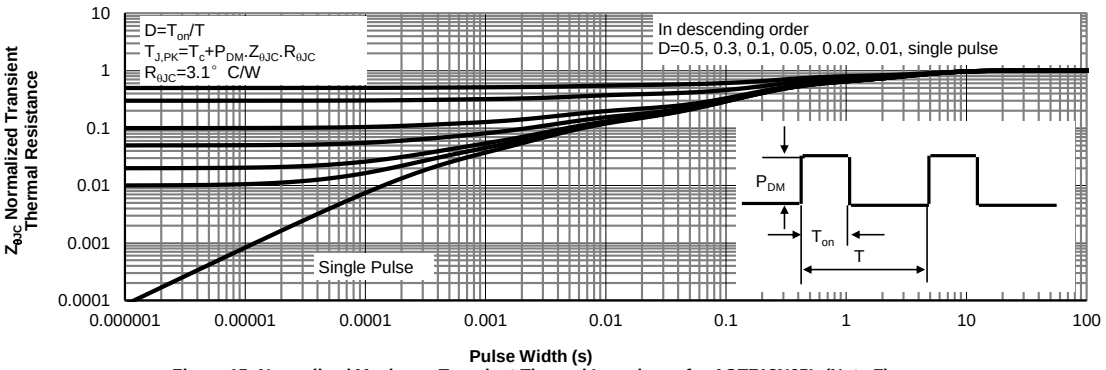
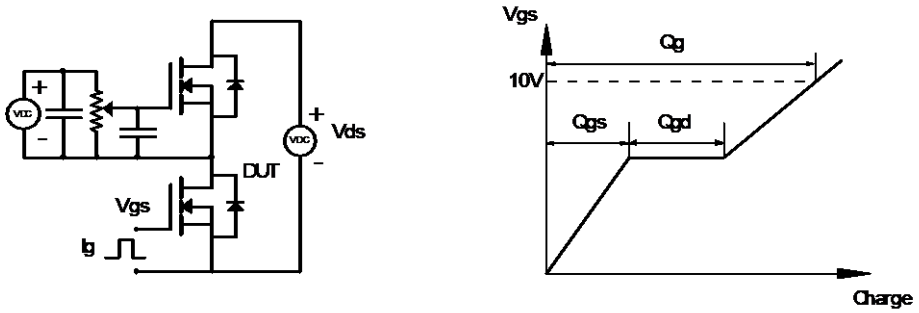
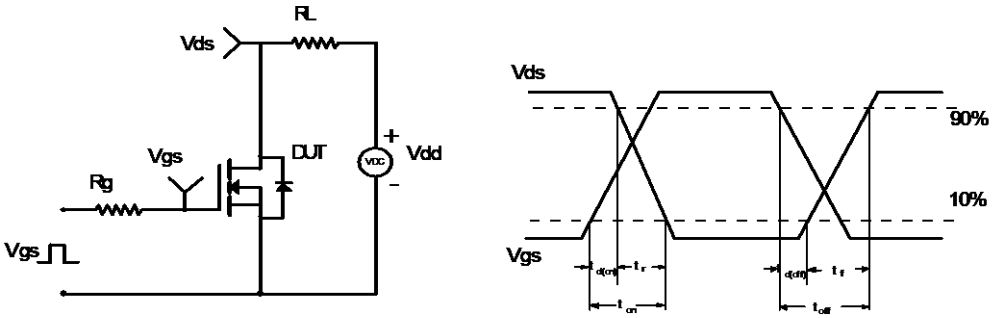


Figure 15: Normalized Maximum Transient Thermal Impedance for AOTF12N65L (Note F)

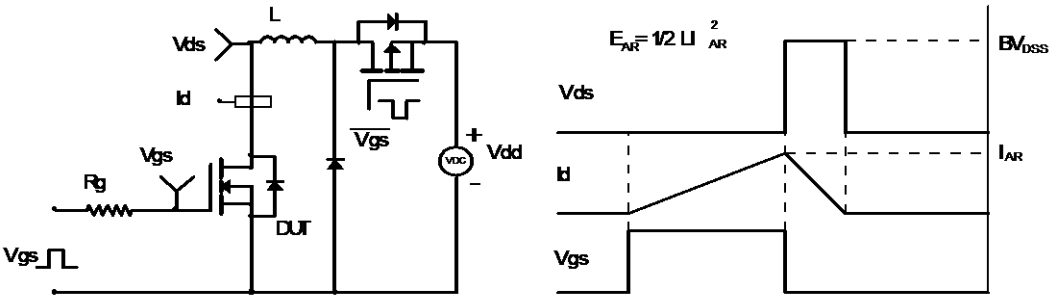
Gate Charge Test Circuit & Waveform



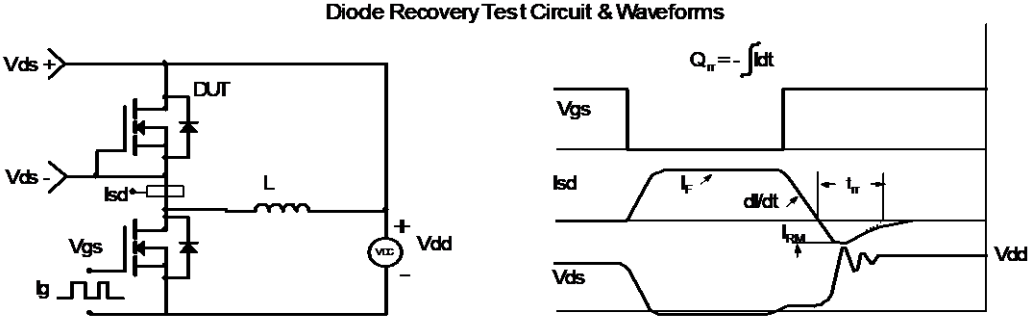
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